LP-OSFPTOX 1.25 Gbps Duplex copper pairs RJ-45 1000BASE-T SFP Transceiver for up to 100 m.

LPOSFPTOX _PFD_ENB01W

Features

- Up to 1.25 Gb/s bi-directional data links.
- Hot-pluggable SFP footprint.
- Extended case temperature range (0°C to +85°C).
- Fully metallic enclosure for low EMI.
- Low power dissipation (1.05 W typical).
- Compact RJ-45 connector assembly.
- Access to physical layer IC via 2-wire serial bus.
- 1000 BASE-T operation in host systems with SERDES interface.
- 10/100/1000Mbps compliant in host systems with SGMII interface.

Applications

 1 Gigabit Ethernet over CAT 5 or higher category cable.



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The LP-OSFPTOX 1.25 Gbps Duplex copper pairs RJ-45 1000BASE-T Small Form Pluggable (SFP) Transceiver for up to 100m (SFP) transceivers is a high performance, cost effective module, compliant with the Gigabit Ethernet and 1000- BASE-T standards as specified in IEEE 802. 3-2002 and IEEE 802.3ab, which supports 1000Mbps data-rate up to a 100 meters reach over unshielded twisted-pair category 5 cable. The module supports 1000 Mbps full duplex data-links with 5-level Pulse Amplitude Modulation (PAM) signals. All four pairs in the cable are used with symbol rate at 250Mbps on each pair. The module provides standard serial ID information compliant with SFP MSA, which can be accessed with address of A0h via the 2wire serial CMOS EEPROM protocol. The physical IC can also be accessed via 2wire serial bus at address ACh.

Standards

-	Compatible with IEEE 802.3z
	Compatible with EDA 21 CFR 1040 10 and 1040 11 Class I



Product selection

Part Number	Product Description							
LP-OSFPT01	10/100/1000Mbps, SGMII interface, Copper SFP with spring latch.							
LP-OSFPT02	1000Mbps only, SERDES interface, Copper SFP with spring latch.							

SFP to Host Connector Pin Out

Pin	Symbol	Name/Description	Note
1	VEET	Transmitter ground (common with receiver ground)	1
2	TFAULT	Transmitter Fault. Not supported	
3	TDIS	Transmitter Disable. PHY disabled on high or open	2
4	MOD_DEF (2)	Module Definition 2. Data line for serial ID	3
5	MOD_DEF (1)	Module Definition 1. Clock line for serial ID	3
6	MOD_DEF (0)	Module Definition 0. Grounded within the module	3
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication.	4
9	VEER	Receiver ground (common with transmitter ground)	1
10	VEER	Receiver ground (common with transmitter ground)	1
11	VEER	Receiver ground (common with transmitter ground)	1
12	RD-	Receiver Inverted DATA out. AC coupled	
13	RD+	Receiver Non-inverted DATA out. AC coupled	
14	VEER	Receiver ground (common with transmitter ground)	1
15	VCCR	Receiver power supply	
16	VCCT	Transmitter power supply	
17	VEET	Transmitter ground (common with receiver ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC coupled	
19	TD-	Transmitter Inverted DATA in. AC coupled	
20	VEET	Transmitter ground (common with receiver ground)	1

Table 1	
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Note	Notes:							
1	Circuit ground is connected to chassis ground							
2	PHY disabled on TDIS > 2.0V or open, enabled on TDIS < 0.8V							
3	Should be pulled up with 4.7k – 10k Ohms on host board to a voltage between 2.0 V and 3.6 V.MOD_DEF (0) pulls line low to indicate module is plugged in.							
4	LVTTL compatible with a maximum voltage of 2.5V. Not supported on LP-OSFPT0X.							

SFP to host connector pin assignments and descriptions.

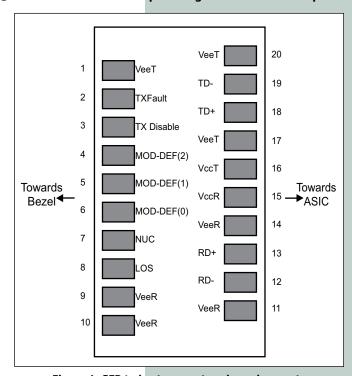


Figure 1. SFP to host connector pin assignments and descriptions



Interfaz de Potencia eléctrica en +3.3V Volt

The LP-OSFPT0X has an input voltage range of 3.3 V \pm 5%. The 4 V maximum voltage is not allowed for continuous operation.

+3.3 Volt Electrical Power Interface										
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions				
Supply Current	Is		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below				
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND				
Maximum Voltage	Vmax			4	V					
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below				

Table 2. +3.3 Volt electrical power interface

Caution:

Power consumption and surge current are higher than the specified values in the SFP MSA

Low-Speed Signals

MOD_DEF (1) (SCL) and MOD_DEF (2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF (1) and MOD_DEF(2) must be pulled up to host_Vcc.

Low-Speed Signals, Electronic Characteristics										
Parameter	Symbol	Notes/Conditions								
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Output HIGH	VOH	host_Vcc - 0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					

Table 3. Low-speed signals, electronic characteristics.



High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

High-Speed Electrical Interface Transmission Line-SFP										
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions				
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3				
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz				
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz				

Table 4. High-speed electrical interface, transmission line-SFP.

High-Speed Electrical Interface, Host-SFP										
Parámetros	Símbolo	Mín.	Típico	Máx.	Unidades	Notas/Condiciones				
Excursión de voltaje de entrada simple de Terminación	Vinsing	250		1200	mV	Terminación simple				
Excursión de voltaje de Terminación simple de data	Voutsing	350		800	mV	Terminación simple				
Tiempo de alza y caída	Tr,Tf		175		psec	20%-80%				
Impedancia de entrada Tx	Zin		50		Ohm	Terminación simple				
Impedancia de salida Rx	Zout		50		Ohm	Terminación simple				

Table 5. High-speed electrical interface, host-SFP.

General Specifications											
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions					
Data Rate	BR	10		1,000	Mb/sec	IEEE 802.3 compatible. See Notes 2 through 4 below					
Cable Length	L			100	m	Category 5 UTP. BER <10-12					

Table 6. General specifications

	Notes:							
1	Clock tolerance is +/- 50 ppm.							
2	By default, the LP-OSFPT0X is a full duplex device in preferred master mode.							
3	Automatic crossover detection is enabled. External crossover cable is not required.							
4	1000 BASE-T operation requires the host system to have an SGMII interface with no clocks, and the module PHY to be configured per Application Note AN-2036. With a SERDES that does not support SGMII, the module will operate at 1000BASE-T only.							

G Environmental Specifications

The LP-OSFPT0X has an extended range from 0°C to +85°C case temperature as specified in Table 7.

Environmental Specifications									
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions			
Operating Temperature	Тор	0		85	°C	Case temperature			
Storage Temperature	Tsto	-40		85	°C	Ambient temperature			

Table 7. Environmental specifications.



Mechanical Specifications

The host-side of the LP-OSFPTOX conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector. See Figure 2 below for details.

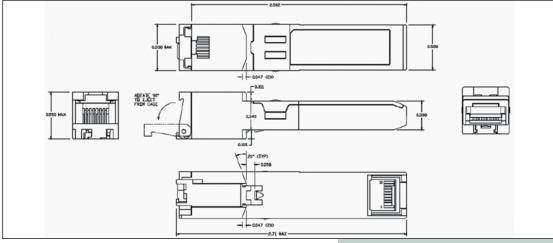


Figure 2. LP-OSFPT0X mechanical dimensions

References

	1	Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA).
	2	IEEE Std 802.3, 2002 Edition. IEEE Standards Department, 2002.
ſ	3	"AT24C01A/02/04/08/16 2-Wire Serial CMOS E2PROM". Atmel Corporation.

How to Order

LP-OSFPT01

1.25 Gbps Duplex copper pairs RJ-45 1000BASE-T SFP Transceiver for up to 100 m, 10/100/1000Mbps, SGMII interface, with spring latch.

LP-OSFPT02

1.25 Gbps Duplex copper pairs RJ-45 1000BASE-T SFP Transceiver for up to 100 m, 1000Mbps, SERDES interface, with spring latch.

LanPro is continuously improving its products and reserves the right to change specifications and availability without prior notice.